SIEMENS

Data sheet

6AG4114-2ML43-4FC3

SIMATIC IPC847D (Rack PC) (Rack PC, 19", 4HU); 2x Gbit Ethernet (IE/PN), RJ45; 1x DVI-I; 2x display ports; 1x COM 1; 2x PS/2; audio; 4x USB 3.0 incl. 1x internal; 3x USB 2.0; Temp. and fan monitoring; Watchdog, Card retainer XEON E3-1268LV3 (4C/8T, 2.3 (3.3) GHz, 8 MB cache VT-D, AMT); Mainboard with PROFINET (3x RJ45, CP 1616-compatible) RAID5, 2 TB (3x 1 TB HDD SATA, striping with parity), in removable frame, hot swap; and 1 TB HDD SATA as hot spare in removable frame, front-side 16 GB DDR3 SD-RAM (2x 8 GB), Dual channel Bus module 11 slots: 3x PCI, 3x PCIE X4, 5x PCIE X16; DVD +/-RW (SLIM) COM2; LPT (1 slot occupied) +PCIe x16 graphics card (dual head: 2x VGA or 2x DVI-D), 1 GB, (1 slot occupied) Windows Server 2008 R2 Standard Edition incl. 5 clients, 64 bit, MUI (de, en, fr, es, it), SP1 SIMATIC PC DiagMonitor V5.0 and Image&Partition Creator V3.5 enclosed 110/240V industrial power supply unit; with NAMUR, Power supply cable USA

Installation type/mounting	
Mounting	For horizontal and vertical installation; prepared for telescopic rails; 19" mounting bracket can be removed externally; tower kit (optional)
Design	Rack PC, 19", 4U
Supply voltage	
Type of supply voltage	100/240 V AC (autorange) 50 / 60 Hz; optional redundant 100/240 V AC; optional 100/240 V AC with UPS functionality incl. maintenance-free lead-tin battery
Line frequency	
Rated value 50 Hz	Yes
Rated value 60 Hz	Yes
Mains buffering	
 Mains/voltage failure stored energy time 	20 ms
Processor	
Processor type	Xeon E3-1275 v3 (4C/8T, 3.5 (3.9) GHz, 8 MB cache); Xeon E3-1268L v3 (4C/8T, 2.3 (3.3) GHz, 8 MB cache); Core i5-4570TE (2C/4T, 2.7 (3.3) GHz, 4 MB cache); Core i3-4330TE (2C/4T, 2.4 GHz, 4 MB cache)
Chipset	Intel DH82C226 PCH
Graphic	
Graphics controller	Onboard graphics controller Intel HD 4600 Graphics integrated into the processor / PCI-Express graphics card (Dual Head: 2x VGA or 2x DVI-D) in the PCIe (x16) slot (optional)
Drives	
Optical drives	DVD±R/RW (SlimLine)
Hard disk	500 GB HDD, 1 TB HDD, 2x 1 TB HDD, RAID1 (2x 1 TB HDD, mirror disks), RAID1 (2x 1 TB HDD, mirror disks) + 1x 1 TB HDD as hot spare, RAID5 (3x 1 TB HDD, striping with parity), RAID5 (3x 1 TB HDD, striping with parity) + 1x 1 TB HDD as hot spare; RAID1 (2x 1 TB HDD SAS, mirror disks), RAID5 (3x 1 TB HDD SAS, striping with parity), RAID5 (3x 1 TB HDD SAS, striping with parity) + 1x 1 TB HDD SAS as hot spare incl. PCIe (x8) RAID SAS controller incl. ZMCP module
SSD	Yes; 240 GB SSD; RAID1 (2x 240 GB SSD, mirror disks)
Slot for drives	Mounted internally on the fixed hard disk support, or mounted internally in vibration/shock-absorbing hard disk support, or mounted at the front in the low-profile removable drive bay (hot-swap in RAID configurations)
Memory	
Main memory	2 GB to 32 GB DDR3-1600 DIMM, ECC optional
Capacity of main memory, max.	32 Gbyte
Hardware configuration	
Slots	
• free slots	11 slots: 7x PCI, 3x PCIe (x4) (1 lane), 1x PCIe (x16) or 3x PCI, 5x PCIe mech. (x16) (4x 4 lanes, 1x 8 lanes), 3x PCIe (x4); all modules to a length of 312 mm can be used

Interfaces	
Interfaces/bus type	1x COM1, 1x COM2 (optional), 1x LPT (optional), 2x DisplayPort, 1x
>	DVI-I, 2x PS/2, audio (Microphone In, Line Out), 7x USB, 2x Gigabit Ethernet, PROFIBUS or PROFINET optional
PROFIBUS/MPI	optionally onboard, isolated, max. 12 Mbit/s, no plug-in card necessary, CP 5622-compatible
USB port	2x USB 3.0, 2x USB 2.0 rear, 1x USB 3.0, 1x USB 2.0 front, 1x USB 3.0 internal
Connection for keyboard/mouse	2x PS/2
serial interface	COM1: 1x RS 232, COM2 (optional): 1x RS 232
parallel interface	optional LPT1
Multimedia	·
Audio In/Out	Yes
Microphone In	Yes
Video interfaces	
Graphics interface	2x DisplayPort and 1x DVI-I onboard; 1x VGA via DVI-VGA adapter cable (optional); graphics card PCIe (x16), Dual Head (2x VGA or 2x DVI-D), 1 GB graphics memory (optional)
Industrial Ethernet	
Industrial Ethernet interface	2x Ethernet (RJ45)
— 100 Mbps	Yes
— 1000 Mbps	Yes
ntegrated Functions	
Monitoring functions	
Temperature monitoring	Yes
Watchdog	Yes
Status LEDs	POWER, ETHERNET 1, ETHERNET 2, PN MPI / DP, WATCHDOG,
	TEMP, FAN, HDD0 ALARM, HDD1 ALARM, HDD2 ALARM, HDD HDD3 ALARM
• Fan	Yes
 Monitoring function via network 	Optional
EMC	
Interference immunity against discharge of static electricity	
 Interference immunity against discharge of static electricity 	±6 kV contact discharge acc. to IEC 61000-4-2; ±8 kV air discharge acc. to IEC 61000-4-2
Interference immunity against high-frequency electromagne	tic fields
 Interference immunity against high frequency radiation 	10 V/m for 80 - 1 000 MHz and 1.4 - 2 GHz, 80% AM acc. to IEC 61000-4-3; 3 V/m for 2 - 2.7 GHz, 80% AM acc. to IEC 61000-4-3; 10 V for 10 kHz - 80 MHz, 80% AM acc. to IEC 61000-4-6
Interference immunity to cable-borne interference	
Interference immunity on supply cables	±2 kV acc. to IEC 61000-4-4, burst; ±1 kV acc. to IEC 61000-4-5, surge symmetric; ±2 kV acc. to IEC 61000-4-5, surge asymmetric
 Interference immunity on signal cables >30m 	±2 kV acc. to IEC 61000-4-4, burst; ±2 kV acc. to IEC 61000-4-5, surge
 Interference immunity on signal cables < 30m 	±1 kV acc. to IEC 61000-4-4, Burst
Interference immunity against voltage surge	
asymmetric interference	±2 kV acc. to IEC 61000-4-5, surge asymmetric
symmetric interference	±1 kV acc. to IEC 61000-4-5, surge symmetric
Interference immunity to magnetic fields	
Interference immunity to magnetic fields at 50 Hz	100 A/m; to IEC 61000-4-8
Emission of conducted and non-conducted interference	
• Interference emission via line/AC current cables	EN 61000-6-3, FCC Class A, EN 61000-6-4, CISPR 22, EN 55022 Class B, EN 61000-3-2 Class D, EN 61000-3-3
Degree and class of protection	
IP (at the front)	IP41
IP (rear)	IP20
Standards, approvals, certificates	
CE mark	Yes; For use in industrial areas as well as domestic, business and
OL Mark	commercial environments (emitted interference: EN 61000-6-3:2007 +A1:2011, noise immunity: EN 61000-6-2:2005)
CSA approval	Yes; Included in cULus
UL approval	Yes
cULus	Yes; UL 60950-1, file number E115352
cULus RCM (formerly C-TICK)	Yes; UL 60950-1, file number E115352 Yes

Dust protection With front door classifiltered Ambient conditions Ambient temperature during operation • Ambient temperature during operation 0 °C to +45 °C, no optical drive, pow maximum 3 removements.	3:2007 +A1:2011, EN 61000-6-2:2005 osed: G2 EN 779, 99% of particles > 0.5 mm are o burner operation, 0 °C to +50 °C, no operation of er dissipation of the expansion cards in total < 30 W, vable drive bays, 0 °C to +40 °C with AC UPS, 0 °C to ware RAID controller
EMC Dust protection With front door of filtered Ambient conditions Ambient temperature during operation • Ambient temperature during operation 0 °C to +45 °C, no optical drive, pow maximum 3 remonents are more than 10 min. Ambient temperature during storage/transportation • min. -20 °C	o burner operation, 0 °C to +50 °C, no operation of er dissipation of the expansion cards in total < 30 W, vable drive bays, 0 °C to +40 °C with AC UPS, 0 °C to
Ambient conditions Ambient temperature during operation • Ambient temperature during operation 0 °C to +45 °C, no optical drive, pow maximum 3 remo +35 °C with hards Ambient temperature during storage/transportation • min. -20 °C	b burner operation, 0 °C to +50 °C, no operation of er dissipation of the expansion cards in total < 30 W, vable drive bays, 0 °C to +40 °C with AC UPS, 0 °C to
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optical drive, pow maximum 3 remo +35 °C with hards Ambient temperature during storage/transportation • min. -20 °C	er dissipation of the expansion cards in total < 30 W, vable drive bays, 0 °C to +40 °C with AC UPS, 0 °C to
● min20 °C	
• max. 60 °C	
Relative humidity	
	to IEC 60068-2-78, IEC 60068-2-30: Operation: 5% to condensation), Storage: 5% to 95% at $25~^{\circ}\text{C}$ (no
Vibrations	
• Vibration resistance during operation acc. to IEC tested according Hz to 500 Hz: 4.9	to DIN IEC 60068-2-6: 10 Hz to 58 Hz: 0.0375 mm, 58 m/s² (0.5 g)
Shock testing	
• Shock load during operation Tested according (5 g), 30 ms, 100	to IEC 60068-2-27, IEC 60068-2-29: half-sine: 50 m/s² shocks per axis
Operating systems	
Enterprise 2015 L 2016 LTSB, multi Edition incl. 5 clie Standard Edition	ate, multi-language (32-bit/64-bit), Windows 10 .TSB, multi-language (64-bit), Windows 10 Enterprise -language (64-bit), Windows Server 2008 R2 Standard nts, multi-language (64-bit); Windows Server 2012 R2 incl. 5 clients, multi-language (64-bit); Windows Server dition incl. 5 clients, multi-language (64-bit)
Additional info on operating system Multi-Language U French, Spanish,	Iser Interface (MUI): 5 languages (English, German, Italian)
without operating system Yes	
Software	
SIMATIC Software Optionally in pack	age with SIMATIC WinCC or WinCC flexible
Dimensions	
Width 430 mm	
Height 177 mm; 4U	
Depth 444 mm	

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last modified: